Technical Data
Data Sheet N1505, Rev. A

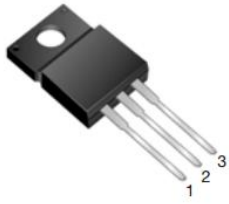
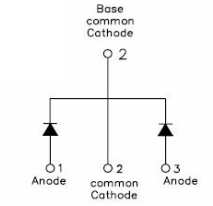
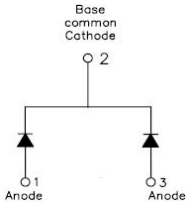
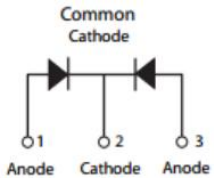
ST60100C/STB60100C/STF60100C
SCHOTTKY RECTIFIER

Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Features

- 150 °C T_J operation
- Ultralow forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Trench MOS Schottky technology
- Terminals finish: Tin Lead-free plated
- This is a Pb − Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

ST60100C	STB60100C	STF60100C
		
		
TO-220AB	D^2PAK	ITO-220AB

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	-	100	V
Average Rectified Forward Current	$I_{F\ (AV)}$	Tc=74°C In DC	30(Per Leg) 60(Per Device)	A
Peak One Cycle Non-Repetitive Surge Current(Per Leg)	I_{FSM}	8.3ms, Half Sine pulse,Tc=25°C	300	A

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Electrical Characteristics:

Characteristics	Symbol	Condition	Typ.	Max.	Units
Forward Voltage Drop(Per Leg)*	V_{F1}	@ 5A, Pulse, T_J = 25 °C @ 10A, Pulse, T_J = 25 °C @ 15A, Pulse, T_J = 25 °C @ 20A, Pulse, T_J = 25 °C @ 30A, Pulse, T_J = 25 °C	0.47 0.54 0.61 0.68 0.82	- - 0.68 - 0.90	V
	V_{F2}	@ 5A, Pulse, T_J = 125 °C @ 10A, Pulse, T_J = 125 °C @ 15A, Pulse, T_J = 125 °C @ 20A, Pulse, T_J = 125 °C @ 30A, Pulse, T_J = 125 °C	0.38 0.51 0.58 0.64 0.74	- - 0.65 - 0.80	V
Reverse Current(Per Leg)*	I_{R1}	@V_R = 70V,T_J = 25 °C @V_R = 100V,T_J = 25 °C	0.012 0.030	- 1	mA
	I_{R2}	@V_R = 70V,T_J = 125 °C @V_R = 100V,T_J = 125 °C	10 15	- 75	mA
Junction Capacitance(Per Leg)	C_T	@V_R = 5V, T_C = 25 °C f_{SIG} = 1MHz	845	-	pF

* Pulse width < 300 μs, duty cycle < 2%

Thermal-Mechanical Specifications:

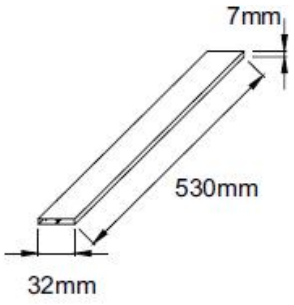
Characteristics	Symbol	ST60100C	STB60100C	STF60100C	Units
Junction Temperature	T_J	-55 to +150			°C
Storage Temperature	T_{stg}	-55 to +150			°C
Typical Thermal Resistance Junction to Case(Per Leg)	$R_{\theta JC}$	2.8	2.8	5	°C/W

Tube Specification

Device	Package	Weight	Shipping
ST60100C	TO-220AB	2.0	50pcs / tube
STB60100C	D^2 PAK	1.85	800pcs / reel
STF60100C	ITO-220AB	2.0	50pcs / tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Tube Specification(TO-220AB/ITO-220AB)



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Ratings and Characteristics Curves

Figure 1
Typical Forward Characteristics

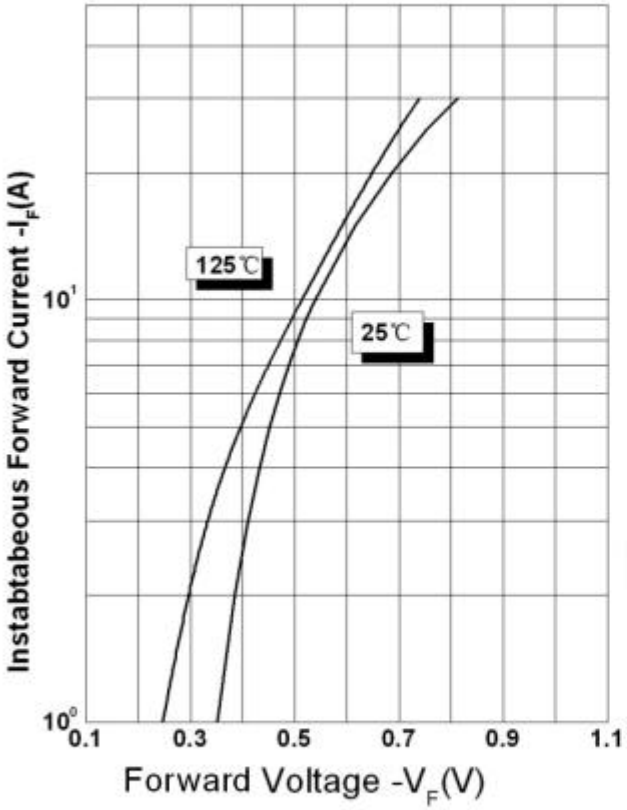


Figure 2
Typical Reverse Characteristics

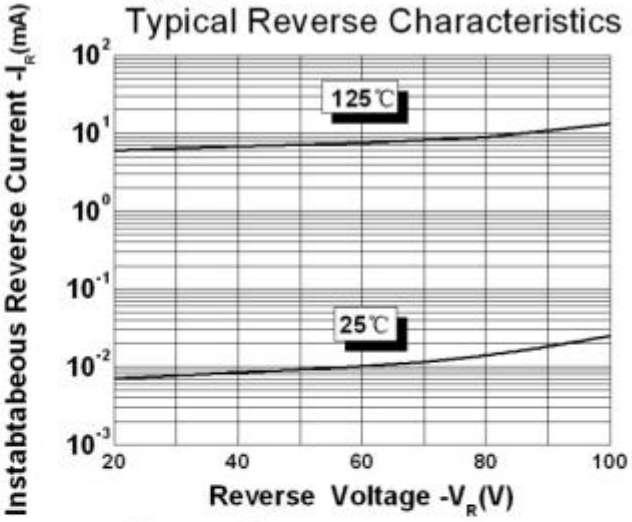
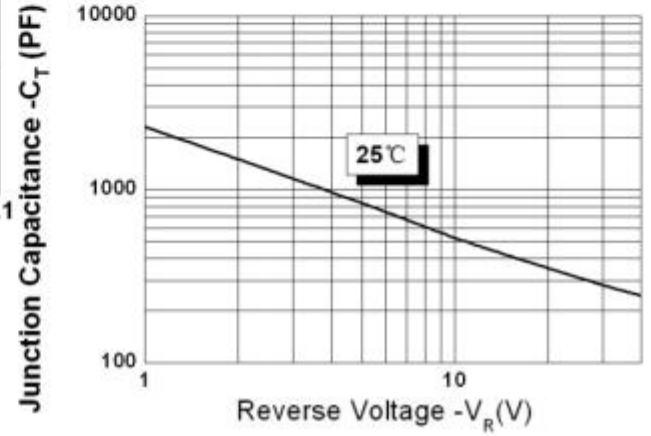


Figure 3
Typical Junction Capacitance



ST60100C
STB60100C
STF60100C

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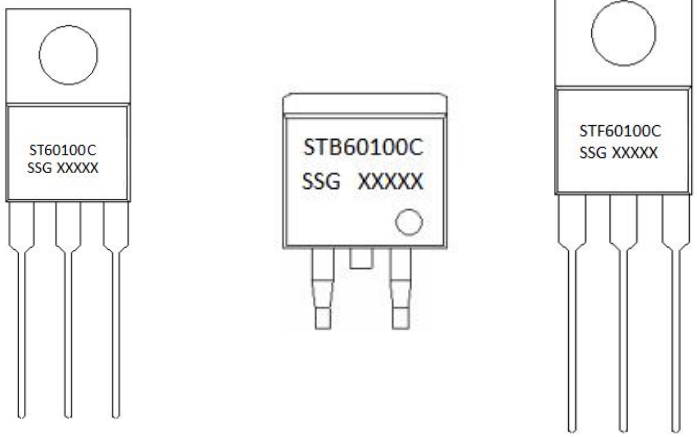
Marking Diagram

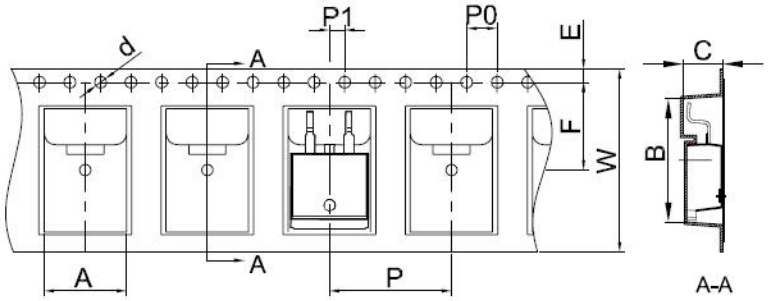


Where XXXXX is YYWWL

ST	= Device Type
B/F	= Package type
60	= Forward Current (60A)
100	= Reverse Voltage (100V)
C	= Configuration
SSG	= SSG
YY	= Year
WW	= Week
L	= Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Carrier Tape Specification D2PAK



SYMBOL	Millimeters	
	Min.	Max.
A	10.70	10.90
B	16.03	16.23
C	5.11	5.31
d	1.45	1.65
E	1.65	1.85
F	11.40	11.60
P0	3.90	4.10
P	15.90	16.10
P1	1.90	2.10
W	23.90	24.30

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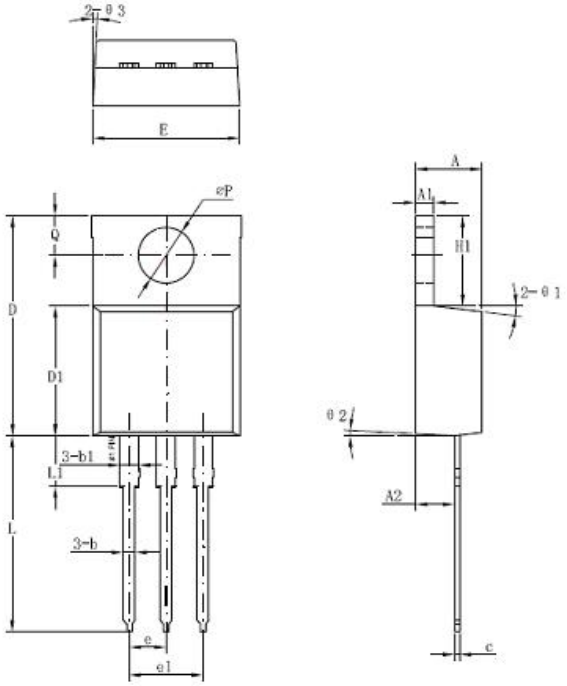
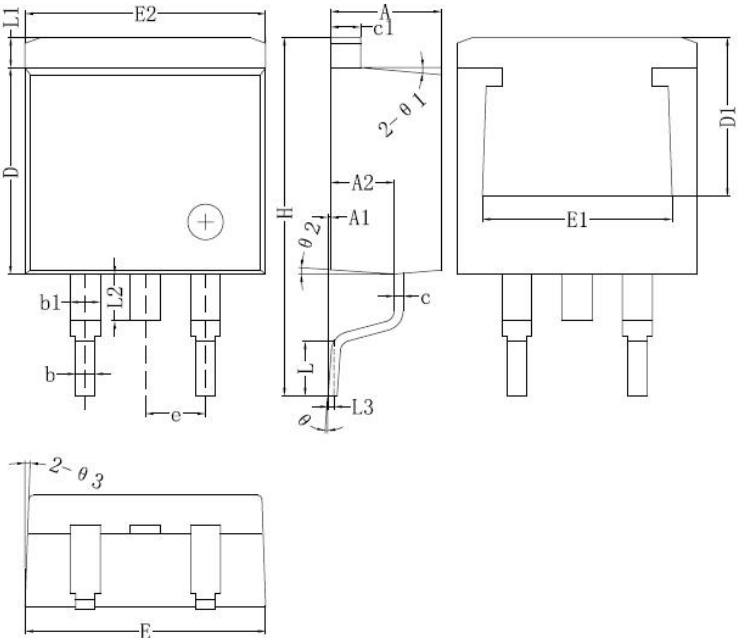
Mechanical Dimensions TO-220AB



Symbol	Dimensions in millimeters		
	Min	Typical	Max
A	3.56	-	4.83
A1	0.51	-	1.4
A2	2.03	-	2.92
b	0.38	-	1.02
b1	1.14	-	1.78
c	0.31	-	0.61
D	14.22	-	16.51
D1	8.38	-	9.42
E	9.65	-	10.67
e	-	2.54	-
e1	-	5.08	-
H1	5.84	-	6.86
L	12.7	-	14.73
L1	-	-	6.35
ΦP	-	3.56	-
Q	2.54	-	3.43

Mechanical Dimensions D²PAK



Symbol	Dimensions in millimeters	
	Min.	Max.
A	4.06	4.83
A1	0	0.26
b	0.51	0.99
b1	1.14	1.78
c	0.31	0.74
c1	1.14	1.65
D	8.38	9.65
D1	6.4	
E1	6.22	
E2	9.65	10.67
e	2.54BSC	
H	14.6	15.88
L	1.78	2.8
L1	-	1.68
L2	-	2.2
L3	0.255BSC	
Θ	0	8°

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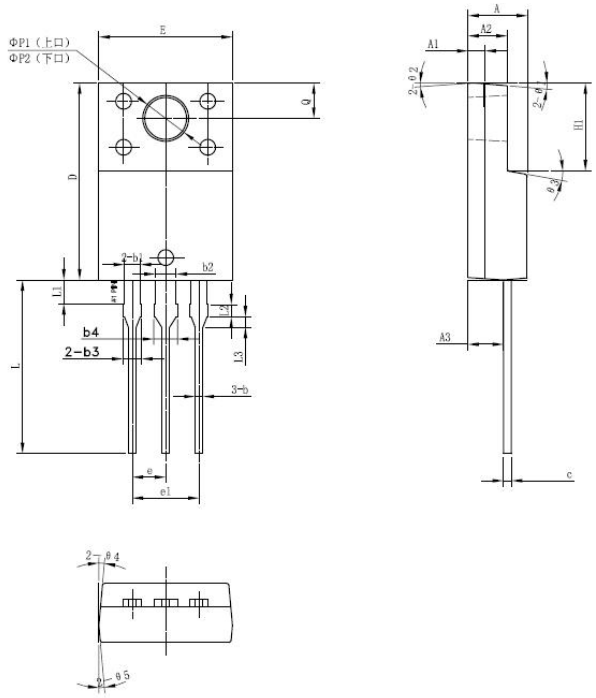
Mechanical Dimensions ITO-220AB



Symbol	Dimensions in millimeters		
	Min.	Typical	Max.
A	4.30	4.50	4.70
A1	1.10	1.30	1.50
A2	2.80	3.00	3.20
A3	2.50	2.70	2.90
b	0.50	0.60	0.75
b1	1.10	1.20	1.35
b2	1.50	1.60	1.75
b3	1.20	1.30	1.45
b4	1.60	1.70	1.85
c	0.50	0.60	0.75
D	14.80	15.00	15.20
E	9.96	10.16	10.36
e		2.55	
e1		5.10	
H1	6.50	6.70	6.90
L	12.70	13.20	13.70
L1	1.60	1.80	2.00
L2	0.80	1.00	1.20
L3	0.60	0.80	1.00
ΦP1(上口)	3.30	3.50	3.70
ΦP2(下口)	2.99	3.19	3.39
Q	2.50	2.70	2.90
Θ1		5°	
Θ2		4°	
Θ3		10°	
Θ4		5°	
Θ5		5°	

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